

## MODULAR MISSILE BORNE COMPUTERS

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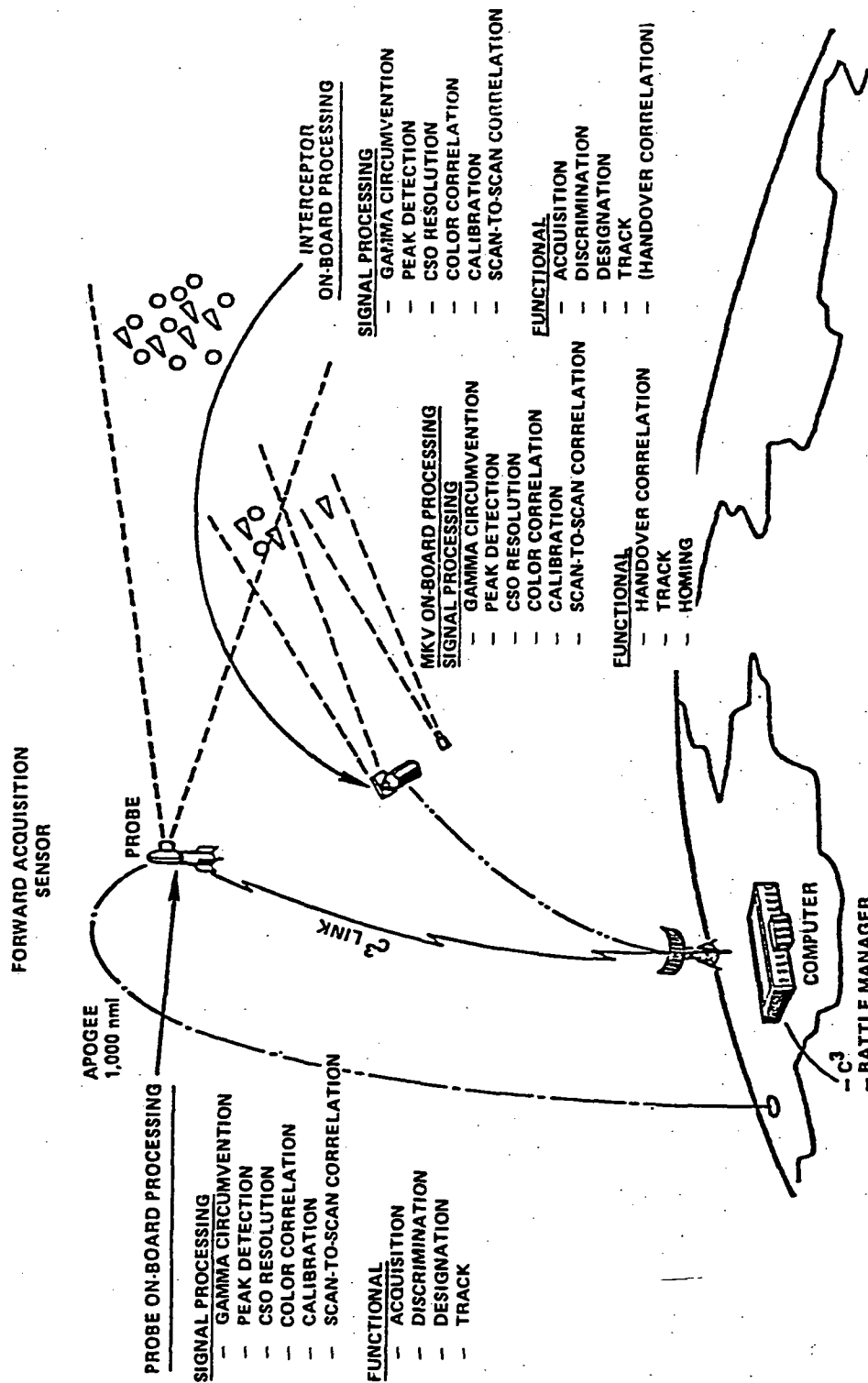
The increasing real time signal and data processing loads on-board BMD interceptors cannot be met with currently available and flyable processors. The Modular Missile Borne Computer is being developed to provide a solution to that problem through the use of a collection of microprocessors in a distributed processing system.

This paper discusses the Modular Missile Borne Computer's architecture with emphasis on how that architecture evolved from a careful analysis of both the physical constraints and the processing requirements. The development techniques used are generally applicable to real-time data processing systems and have resulted in the achievement of one of our most significant design goals. This goal is a modular, flexible, extensible system capable of adapting to evolving BMD problems as well as others where an ultra-high performance distributed processor is desirable.

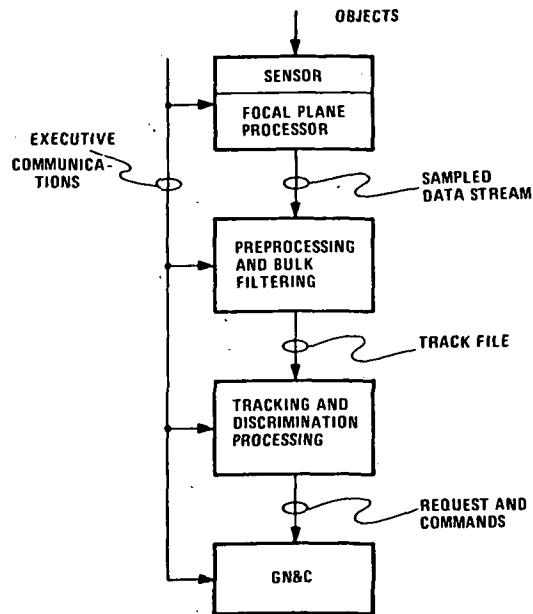
The general objective for the MMBC program is the development of a data processing system which lends itself readily to system growth, reconfiguration and changes in application or environment. Given the constraints and requirements imposed by the BMD threat, scenarios and environmental considerations, four driving architectural considerations result:

- The required processing is real time.
- There is a massive quantity of data and it is received at a rapid rate.
- A high degree of modularity, flexibility and potential for growth is desired in MMBC.
- MMBC must be capable of performing in an extremely hostile operating environment (e.g. shock, vibration, temperature, and nuclear).

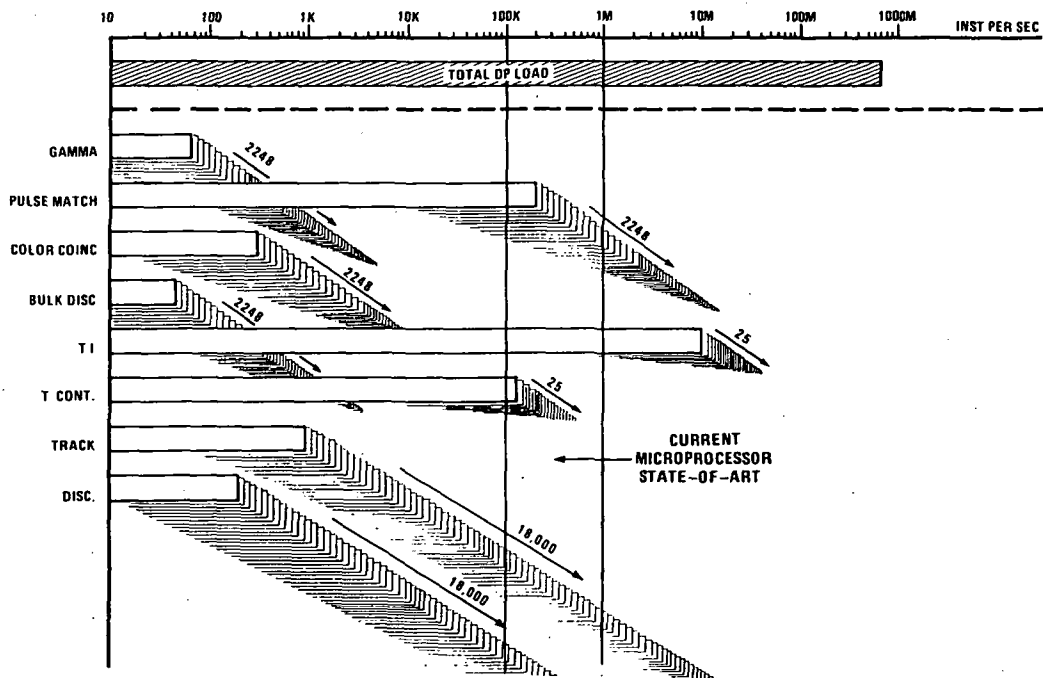
# DATA PROCESSING IN A MIDCOURSE SYSTEM



## HIGH LEVEL PROCESSOR STRUCTURE

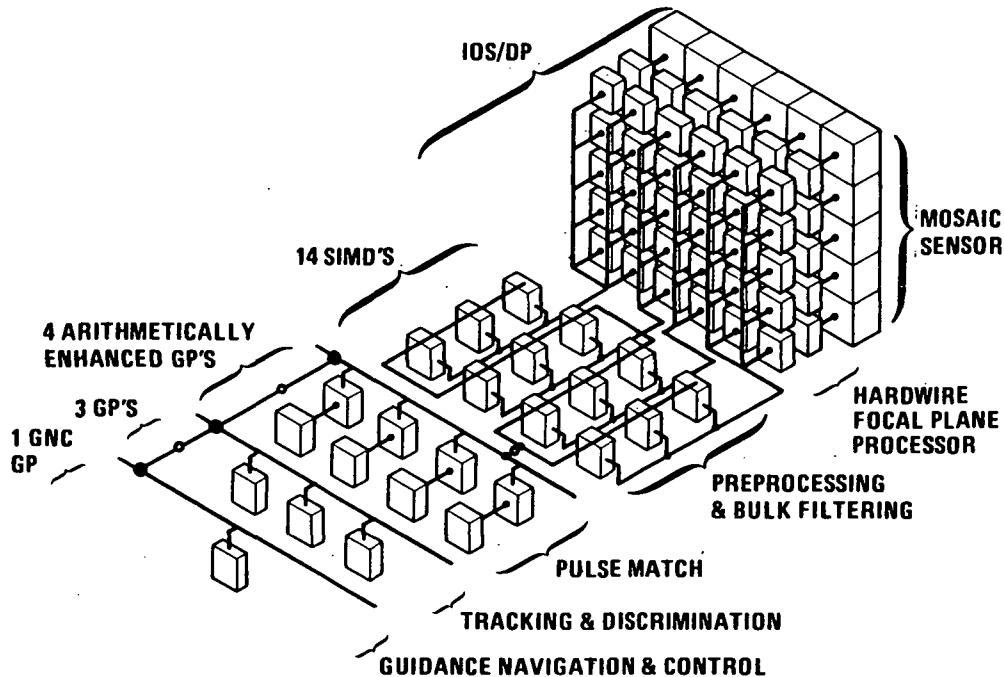


TOTAL DP LOAD IS COMPOSED OF  
MANY SMALL, INDEPENDENT LOADS



# MODULAR MISSILE-BORNE COMPUTERS

**OBJECTIVE:** INVESTIGATE ADVANCED PREPROCESSING TECHNOLOGY & THE APPLICATION OF MODULAR, FLEXIBLE, EXTENDABLE MICROCOMPUTER ARRAYS TO PERFORM THE REAL TIME DATA PROCESSING NECESSARY ON BOARD A BMD INTERCEPTOR.



**RATIONALE:** ADVANCES IN INTERCEPTOR & TECHNOLOGY AS WELL AS INCREASING COMPUTATION OF BMD FUNCTIONS ON BOARD IMPOSE REQUIREMENTS ON THE DATA PROCESSOR THAT CANNOT BE MET BY CONVENTIONAL COMPUTER ARCHITECTURES. MODULAR, FLEXIBLE, AND EXTENDABLE COMPUTER STRUCTURES ARE REQUIRED TO MEET THE NEEDS OF THE FLUID AND RAPIDLY EVOLVING BMD SYSTEMS.

## BENEFITS OF MICROPROCESSORS

- ALLOW MAXIMUM USE OF LSIC HARDWARE
  - MINIMIZES SIZE/WEIGHT/POWER/INTERCONNECTS
- SPECIAL PURPOSE OPERATION CAN BE ACHIEVED THROUGH MICROPROGRAMMING
- SIMULTANEOUS OPERATION OF MANY REAL TIME HARDWARE UNITS DRASTICALLY REDUCES NEED FOR MULTIPROGRAMMING
  - REDUCED SOFTWARE COST
  - REDUCED OVERHEAD TIME
- ALLOWS MAXIMUM MODULARITY TO BE ACHIEVED WHICH IMPROVES
  - FAULT TOLERANCE
  - FLEXIBILITY/ALTERABILITY

## APPROXIMATE CAPABILITIES AND REQUIREMENTS

PROCESSING SECTION	PROCESSOR CONFIGURATION	REQUIREMENT	CAPABILITY
<b>PREPROCESSING AND BULK FILTERING</b>			
DMX TO PULSE MATCH	14 SIMD (1 TO 3 MIPS EA)	22 MIPS	~40 MIPS*
PULSE MATCH	4 GP W/SPECIAL ARITHMETIC (15 MIPS FOR PULSE MATCH; 1 MIPS OTHERWISE)	43 MIPS	45 MIPS
TRACKING AND DISCRIMINATION	3 GP (1 MIPS EACH)	151 KIPS	3 MIPS
GUIDANCE NAVIGATION AND CONTROL	1 GP (500 KIPS)	185 KIPS	500 KIPS
<b>TOTAL CAPACITY</b>		<b>88.5 MIPS</b>	

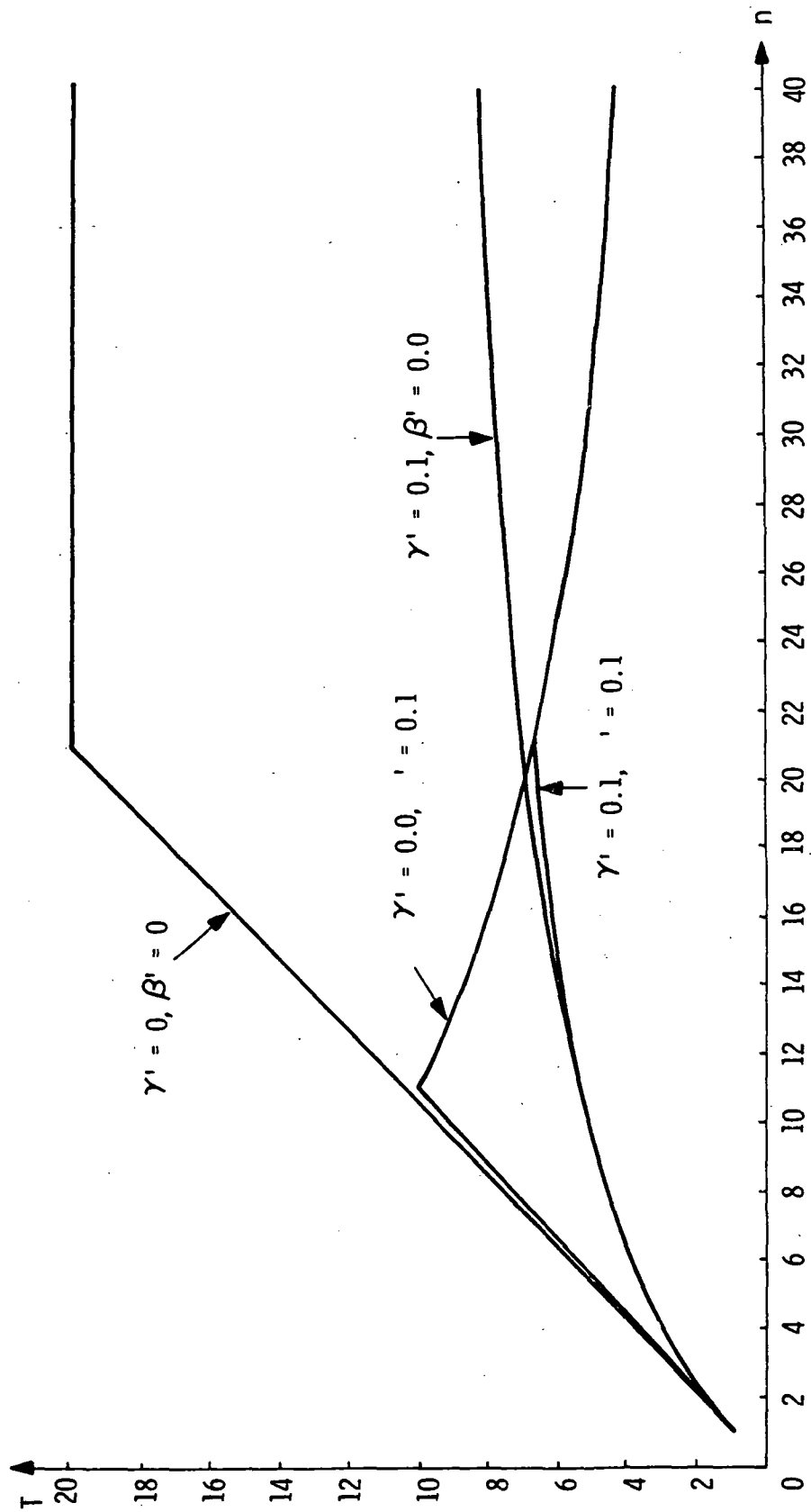
\*HIGH THROUGHOUT REQUIRED TO ABSORB OVERHEAD AND SATISFY REAL-TIME RESPONSE REQUIREMENT.

EACH COMPUTER IN MMBC IS "TUNED" TO PERFORM WELL IN ITS AREA OF APPLICATION.  
E.G., MULTIPLE DATA STREAM PROCESSORS IN BULK FILTERING; PIPELINED, FAST ARITHMETIC UNIT IN PULSE MATCH.

## CHARACTERISTICS OF HARDWARE MODULES

GENERAL PROCESSING ELEMENT (16 BITS)	1 MIPS
SIMD PE (3 ALU'S)	3 MIPS
VOA PROCESSOR	15 MIPS/5 MIPS
LOCAL MEMORY (3 PORT RAM)	
READ ACCESS TIME	270 ns
WRITE ACCESS TIME	75 ns
COMMON BULK MEMORY	
READ	375 ns
WRITE	140 ns
CYCLE	425 ns
GLOBAL BUS (3 BUSES)	
TRANSFER RATE	1 M WORDS/S 1 M WORDS/S
CAN HANDLE 40 K TRACKS/SEC/GLOBAL BUS UTILIZATION	60%

# IDEALIZED SHARING-THROUGHPUT VERSUS NUMBER OF PROCESSORS

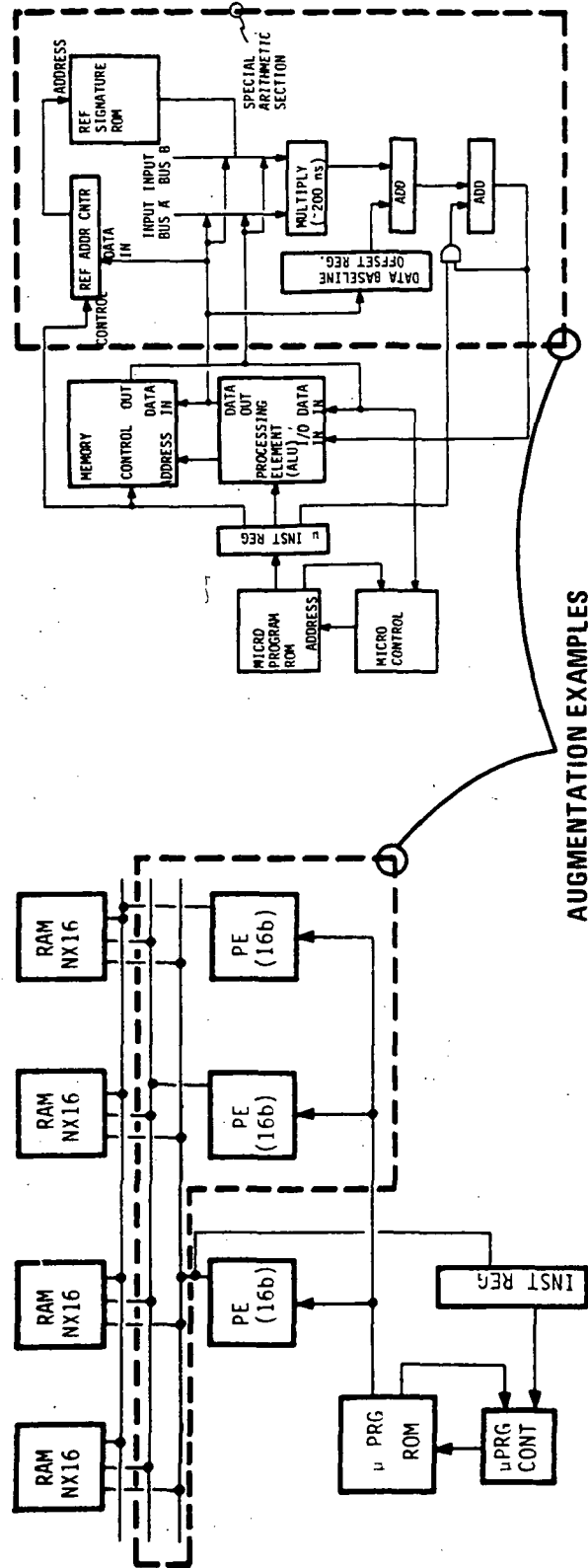


# HARDWARE ARCHITECTURE

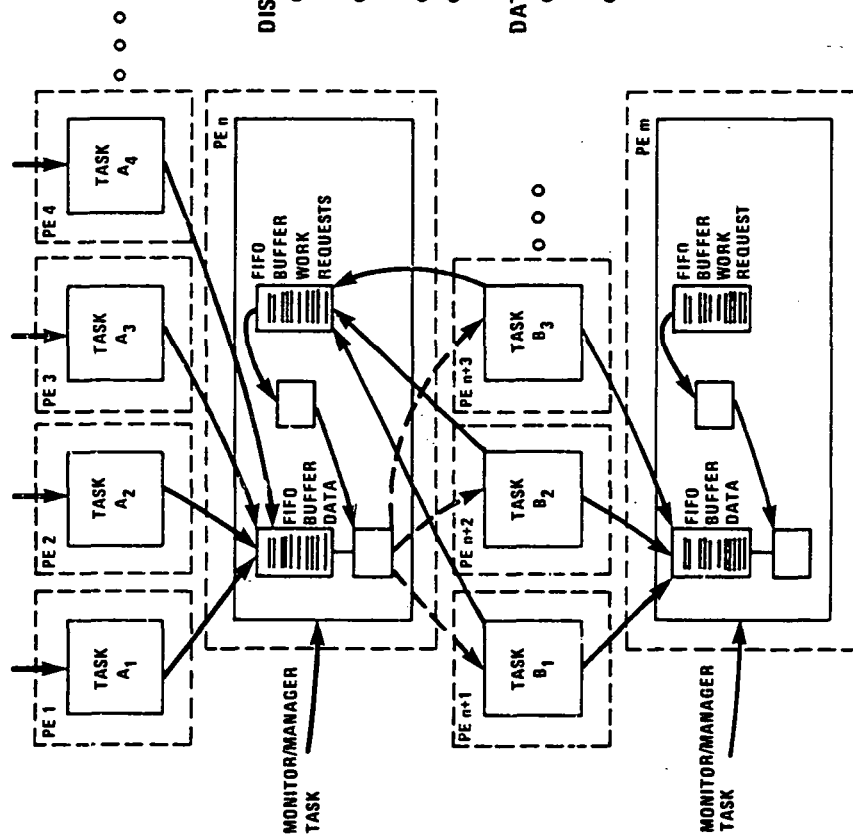
- REQUIRES MULTICOMPUTER
- MODULARITY, FLEXIBILITY, EXTENDABILITY REQUIRED
- OVERHEAD RESULTING FROM DISTRIBUTION MUST BE CONTROLLED
- REQUIRES SPECIAL PURPOSE HARDWARE
- SYSTEM MUST BE MANAGEABLE
- NO. OF COMPUTERS LIMITED BY SIZE, WT., POWER, PROBLEM STRUCTURE

## THEREFORE:

- EACH COMPUTER SHOULD BE AS POWERFUL AS POSSIBLE
- EACH COMPUTER CAN BE AUGMENTED TO PERFORM A CLASS OF ALGORITHMS WELL
- HARDWARE MUST ADAPT EASILY TO ALGORITHM STRUCTURES



## SOFTWARE ARCHITECTURE



### DISTRIBUTED HARDWARE:

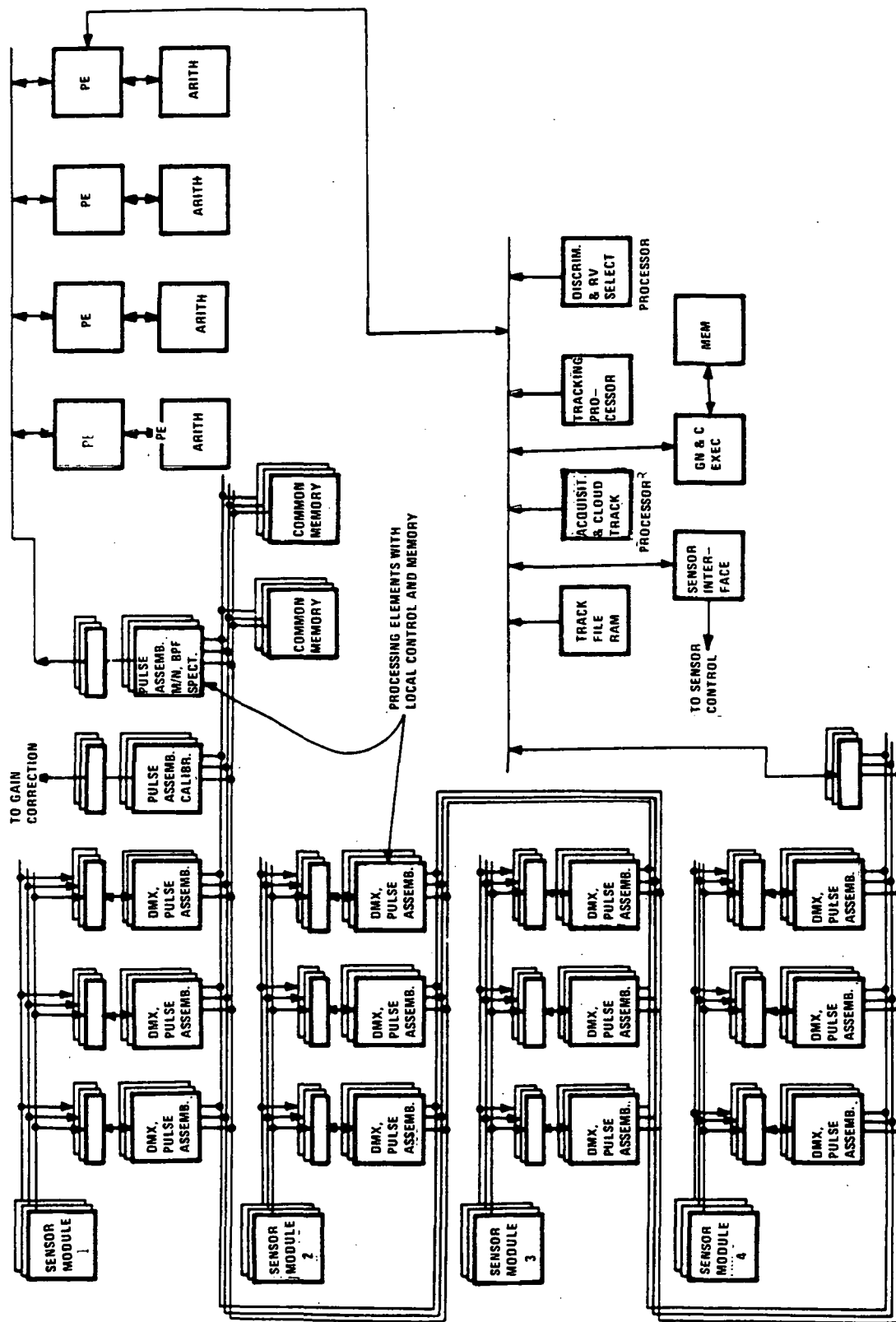
- NATURALLY DISCIPLINES SOFTWARE DESIGN AND IMPLEMENTATION
- MAKES STRUCTURED SOFTWARE DESIGN THE EASIEST APPROACH
- PROVIDES TIGHTLY DISCIPLINED INTERFACES
- LIMITS EFFECTS OF SOFTWARE FAULTS/BUGS/CHANGES

### DATA DRIVEN SOFTWARE STRUCTURE:

- ALLOWS GRACEFUL EXPANSION/CONTRACTION (REQUIRES NO SOFTWARE CHANGES)
- PROVIDES INHERENT FAULT TOLERANCE



# PRELIMINARY ARCHITECTURAL CONFIGURATION, ALTERNATIVE A



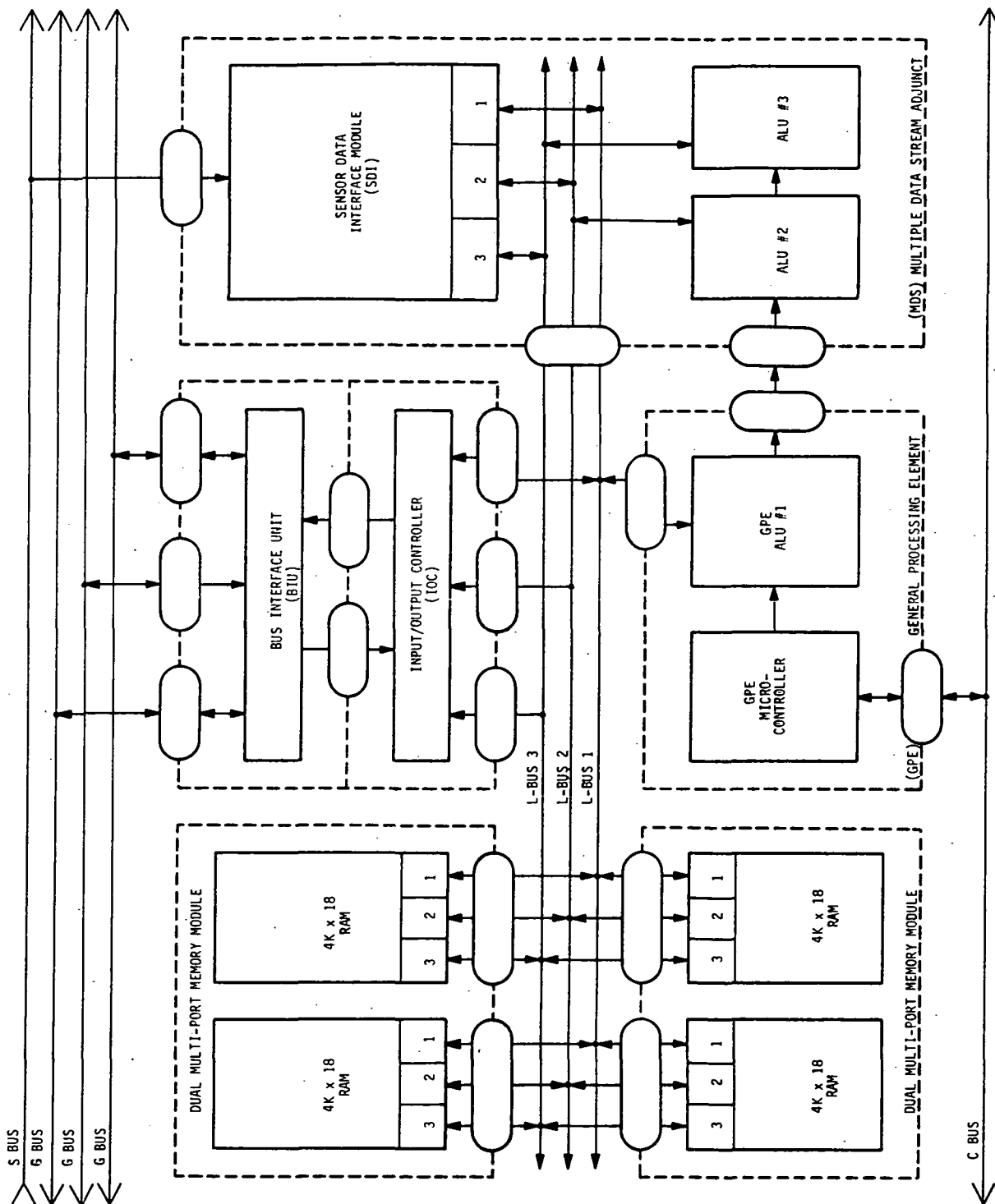
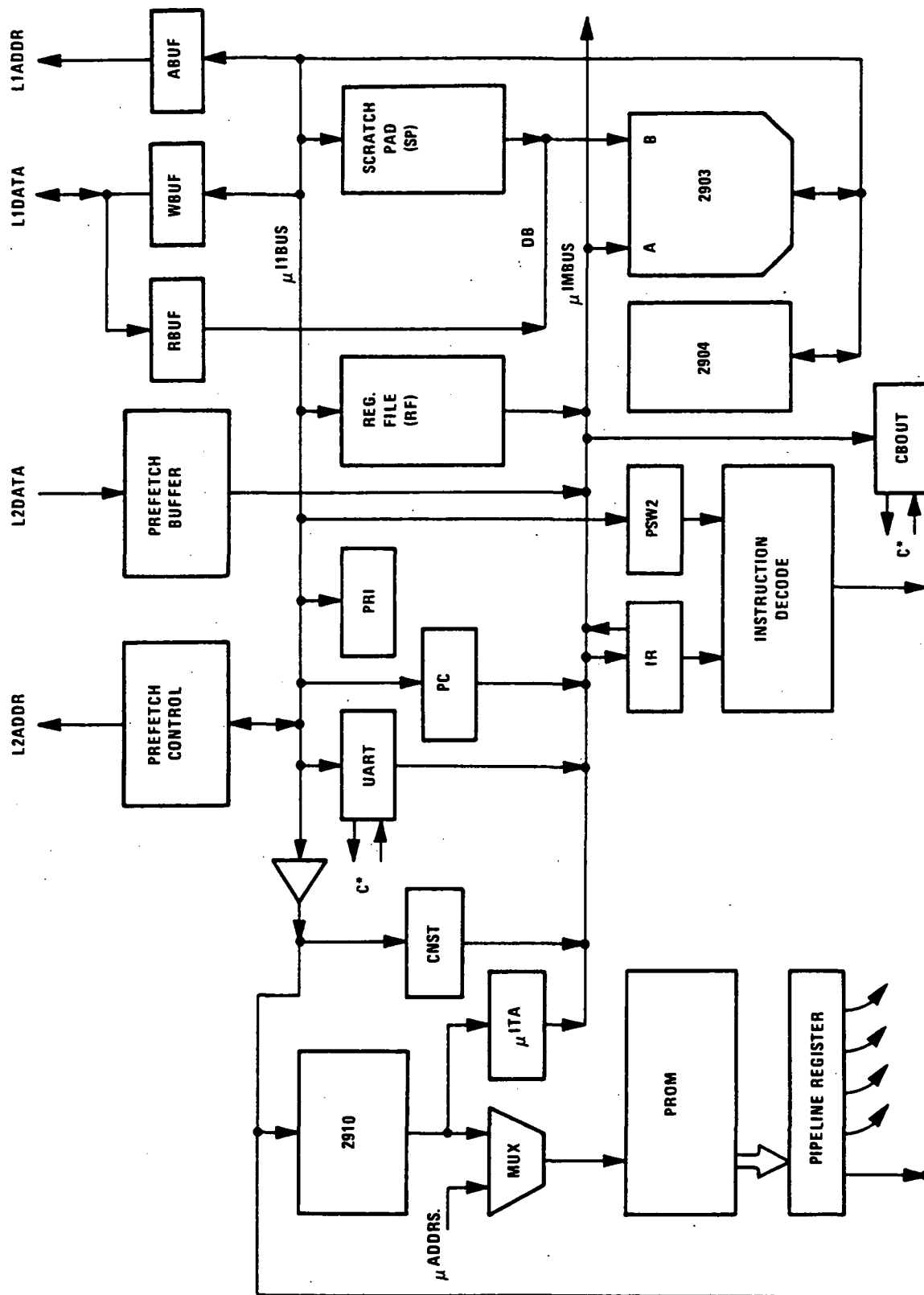
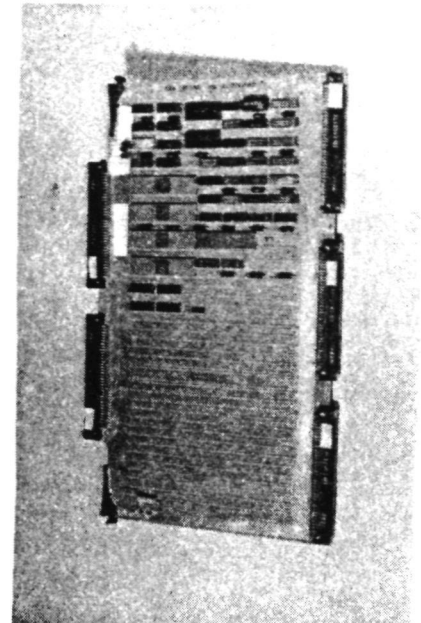
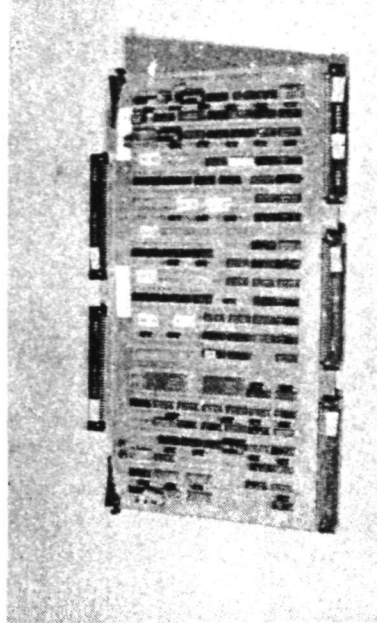
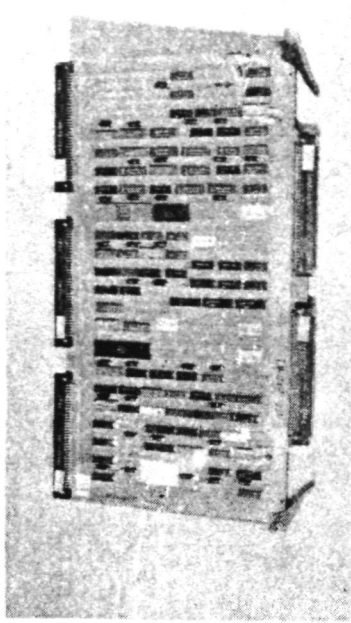


Figure 3.2. SIMD Functional Block Diagram

# GPE BLOCK DIAGRAM



## PROCESSING ELEMENT CPU

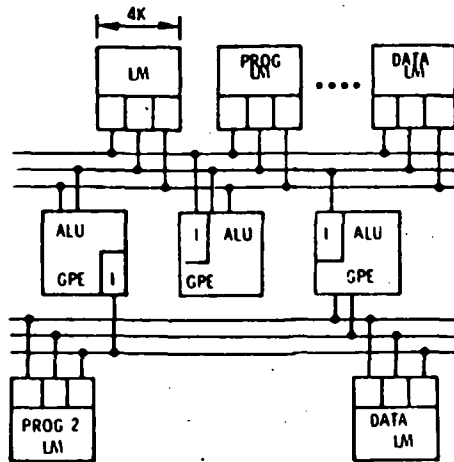


- SINGLE CPU MODULE USED THROUGHOUT SYSTEM

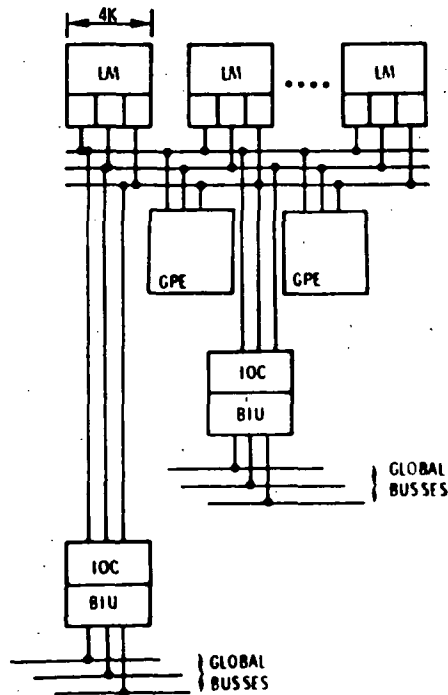
### CHARACTERISTICS

- 1 MIPS PERFORMANCE ( $\sim 1 \mu s$  ADD)
- 16 BIT PARALLEL ORG.
- 65K WORD ADDRESS SPACE
- ASYNCHRONOUS INTERFACES
- MEMORY MAPPED I/O
- LARGE INSTRUCTION SET WITH OPERATING SYSTEMS PRIMITIVES AND FLOATING POINT
- CAPABLE OF AUGMENTATION (I.E., MORE CAPABILITY FOR PULSE MATCH, ETC.)
- 220 LOW POWER SCHOTTKY AND SCHOTTKY TTL IC's
- 96 BIT MICROINSTRUCTION WORD
- MAJOR SECTIONS: ALU, MICROCONTROLLER, CONTROL BUS INTERFACE, REAL-TIME CLOCK

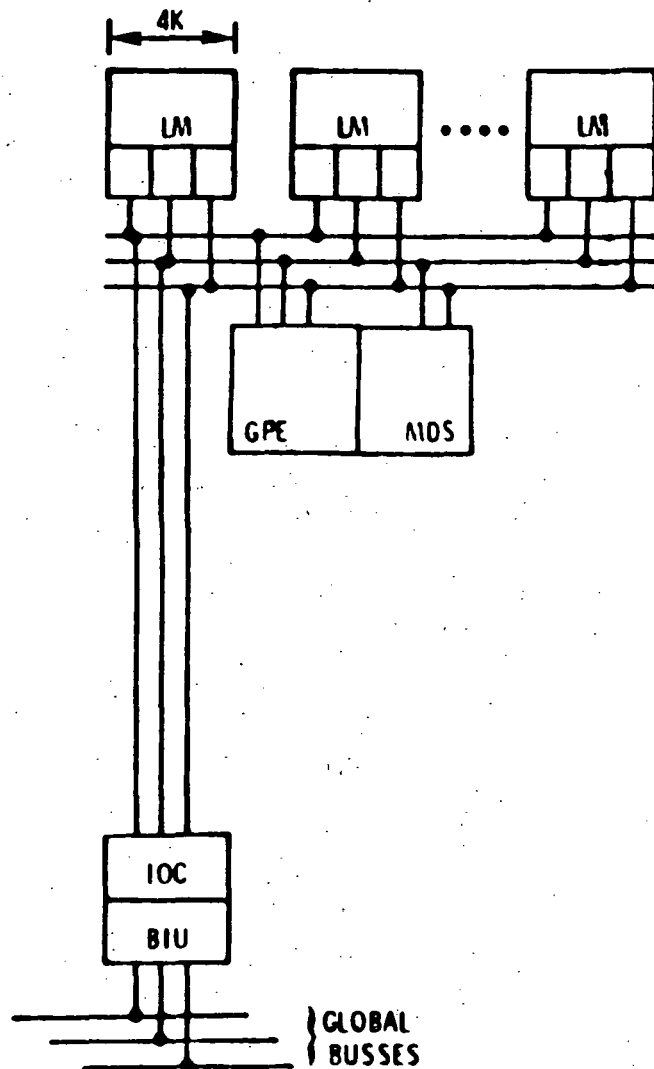
## ALTERNATIVE CONFIGURATIONS OF MMBC MODULES



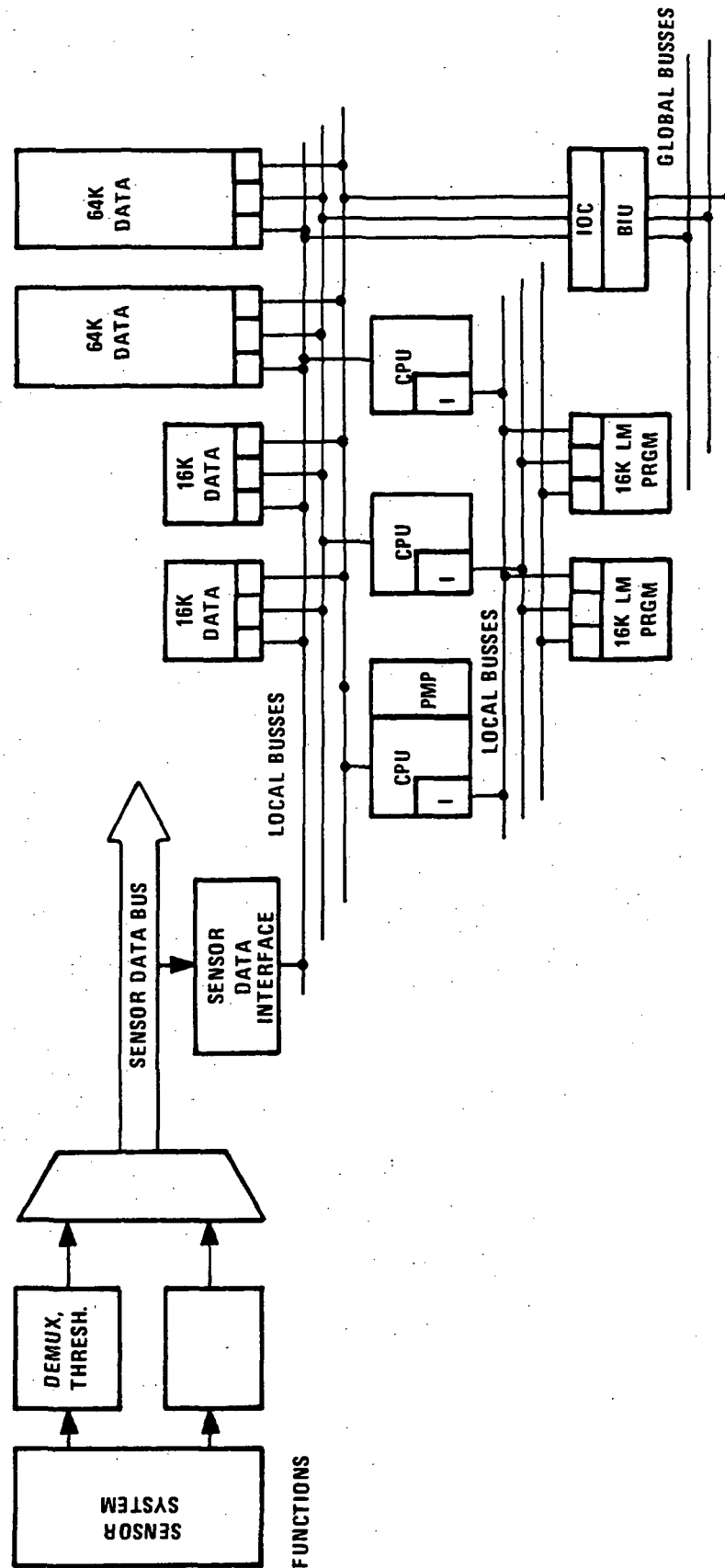
## ALTERNATIVE CONFIGURATIONS OF MMBC MODULES



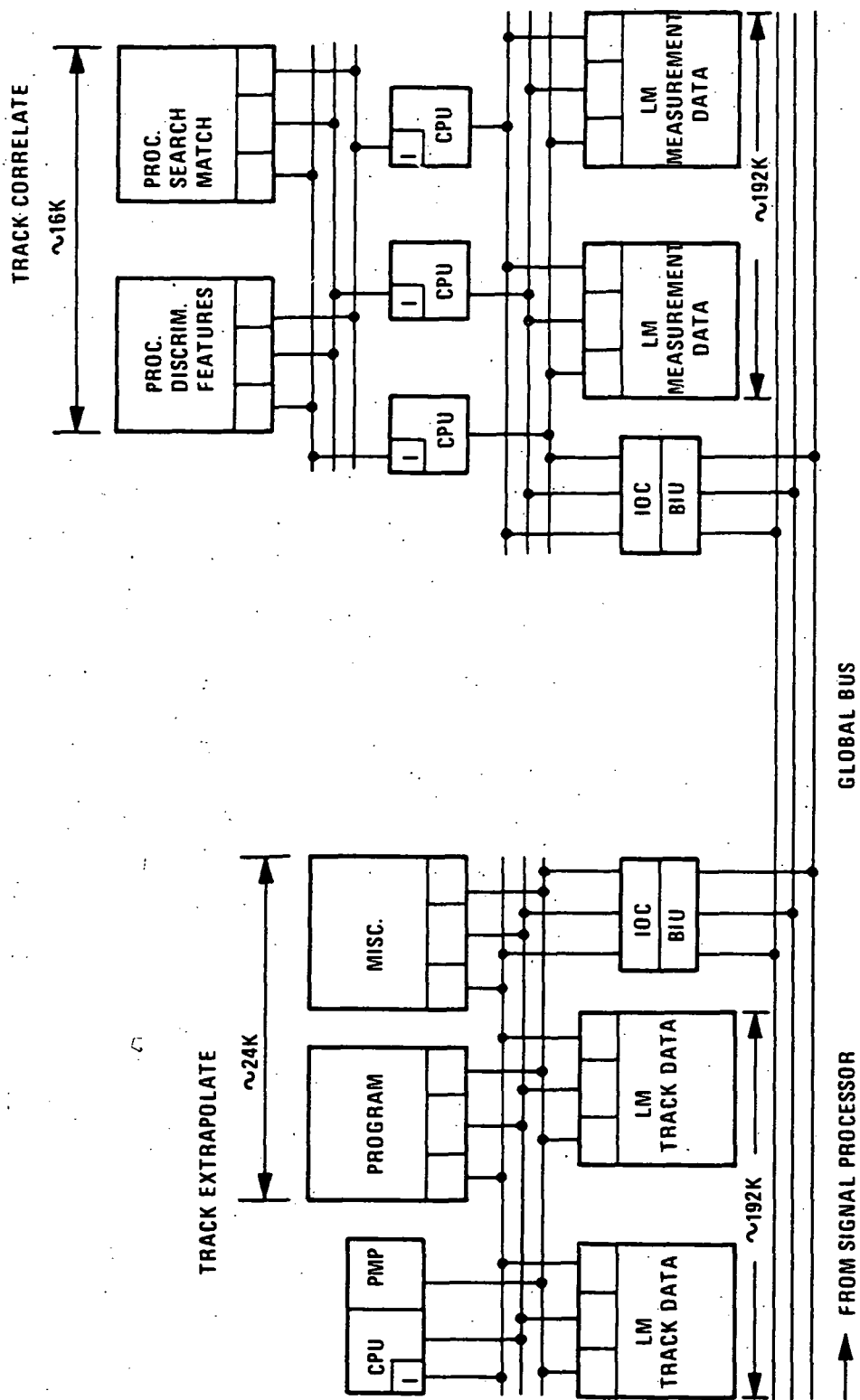
## ALTERNATIVE CONFIGURATIONS OF MMBC MODULES



# EWA PROGRAMMABLE SIGNAL PROCESSOR

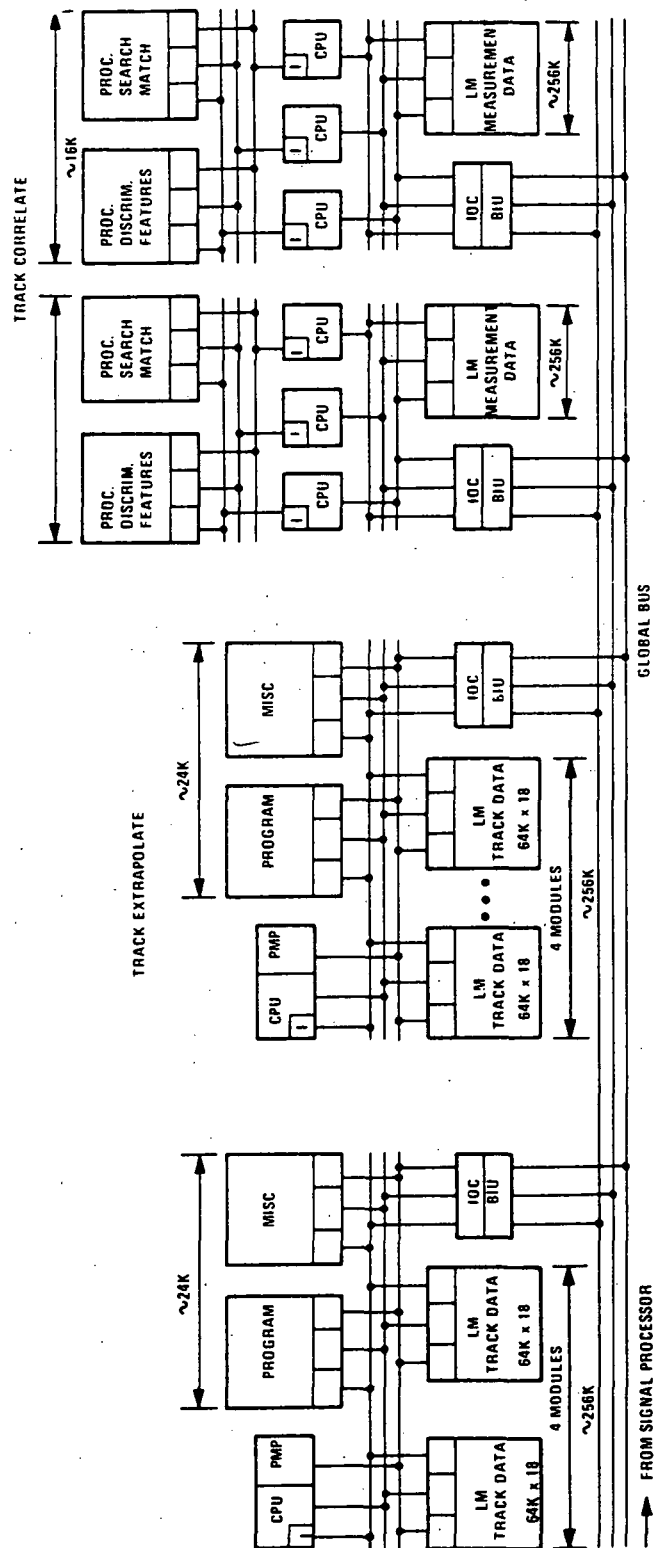


## EWA DATA PROCESSING SYSTEM

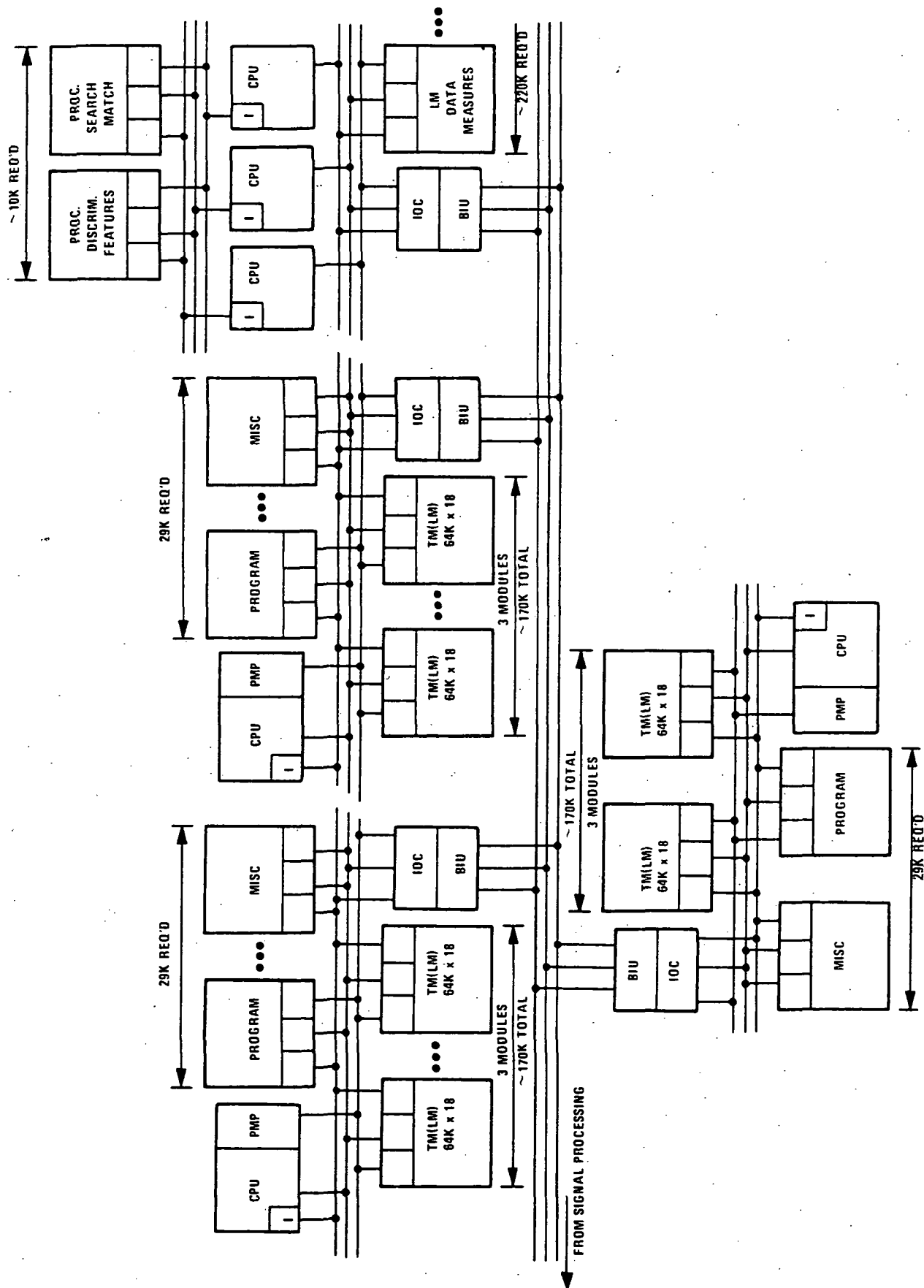




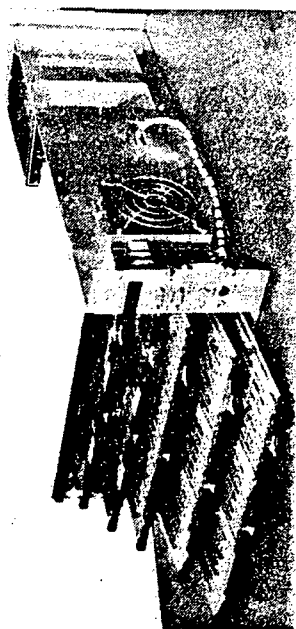
# NEAR-TERM BMD DATA PROCESSING



# ABMD DATA PROCESSING



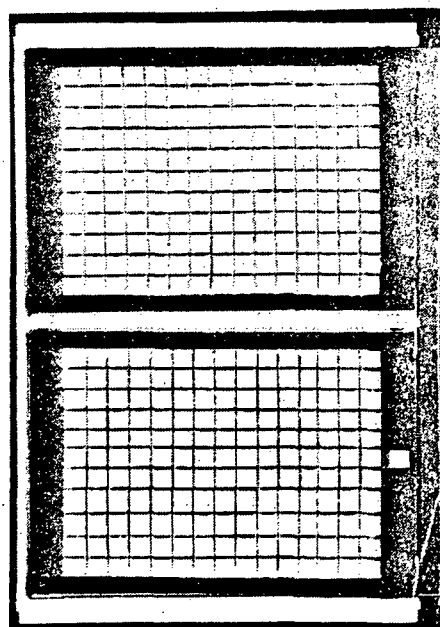
# HARDWARE PACKAGING OPTIONS



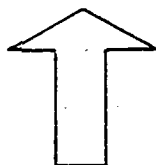
LAB PROTOTYPE IMPLEMENTATION -  
CPU ON 2 1/2"x15" BOARDS



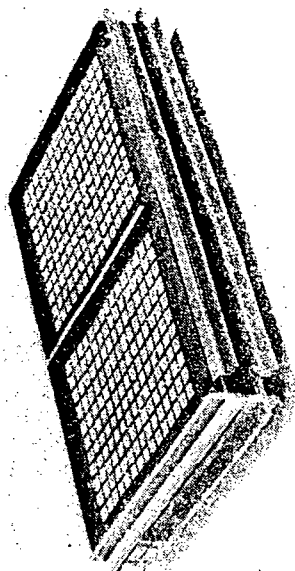
OPTION II



CPU ON SINGLE MODULE -  
LSICs, FLAT PAKS AND  
CHIP CARRIERS

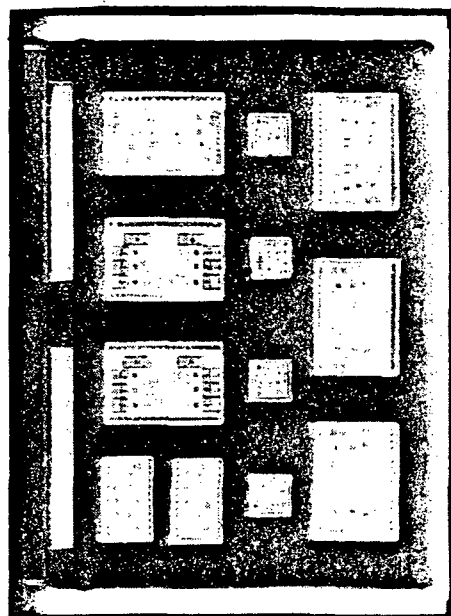


OPTION I

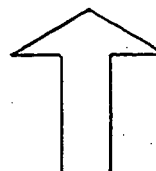


CPU ON DOUBLE MODULE -  
FLAT PAKS AND CHIP CARRIERS

OPTION III

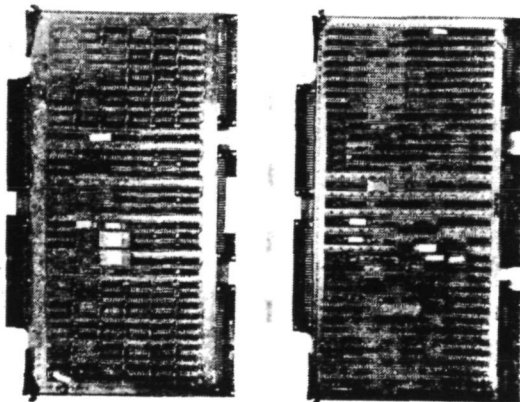


CPU ON HALF MODULE -  
HYBRIDS AND LSICs



# EXAMPLE OF SIZE REDUCTION FOR PACKAGING OPTIONS

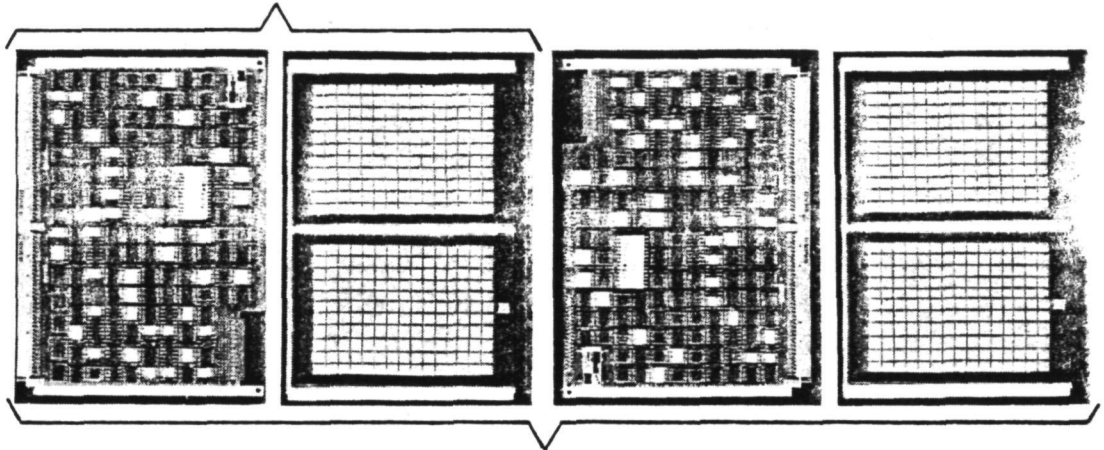
LAB PROTOTYPE



380 ICs  
270 Sq Inches  
56 Watts  
DPs and WR Bds

380 ICs  
180 Sq Inches  
56 Watts  
FPs and Chip  
Carrier on PC Bd

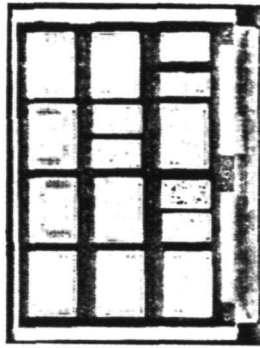
BUS INTERFACE UNIT



OPTION 2  
SINGLE  
MODULE  
(BOTH  
SIDES)

190 ICs  
90 Sq Inches  
≈20 Watts  
LSICs, FPs  
Chip Carriers  
on PC Bd

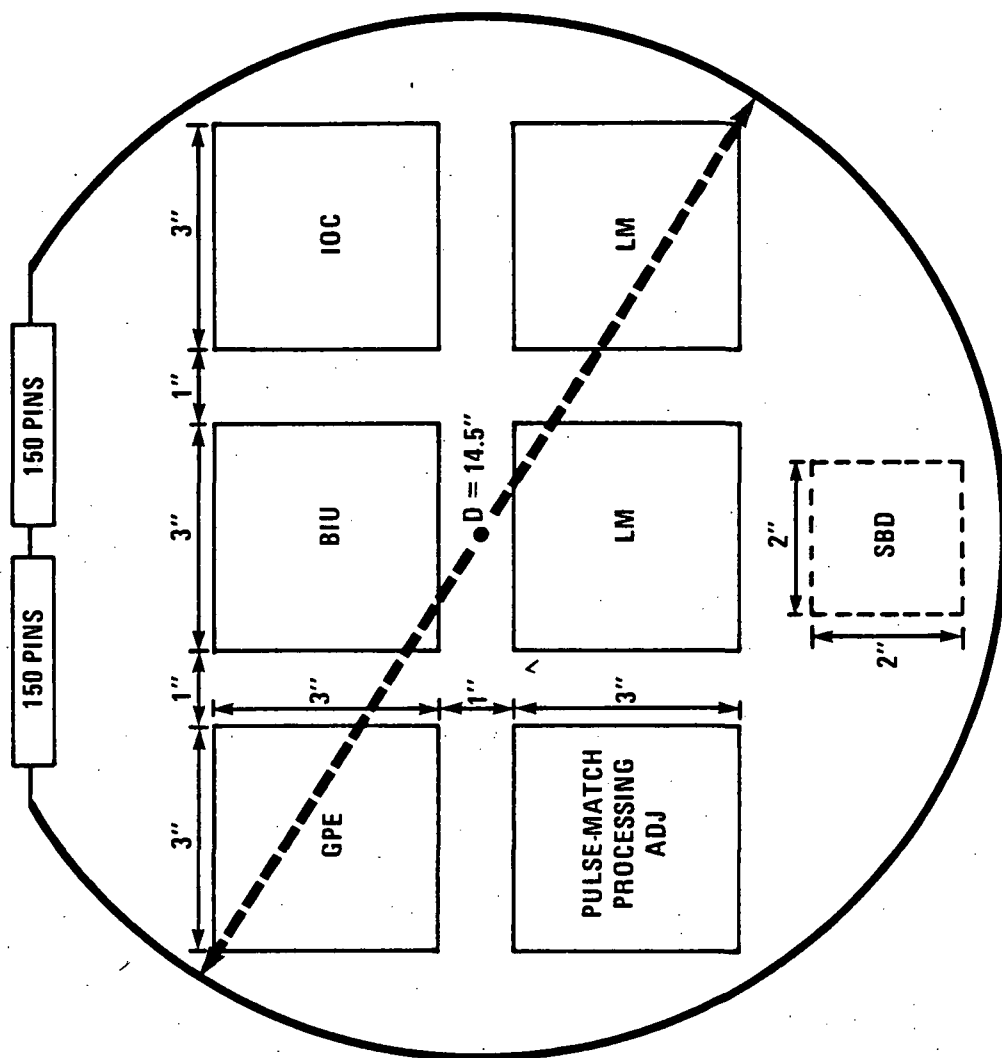
OPTION 3



1/2 MODULE  
(1 SIDE)

190 ICs  
45 Sq Inches  
≈20 Watts  
LSICs and Hybrid  
on PC Bd

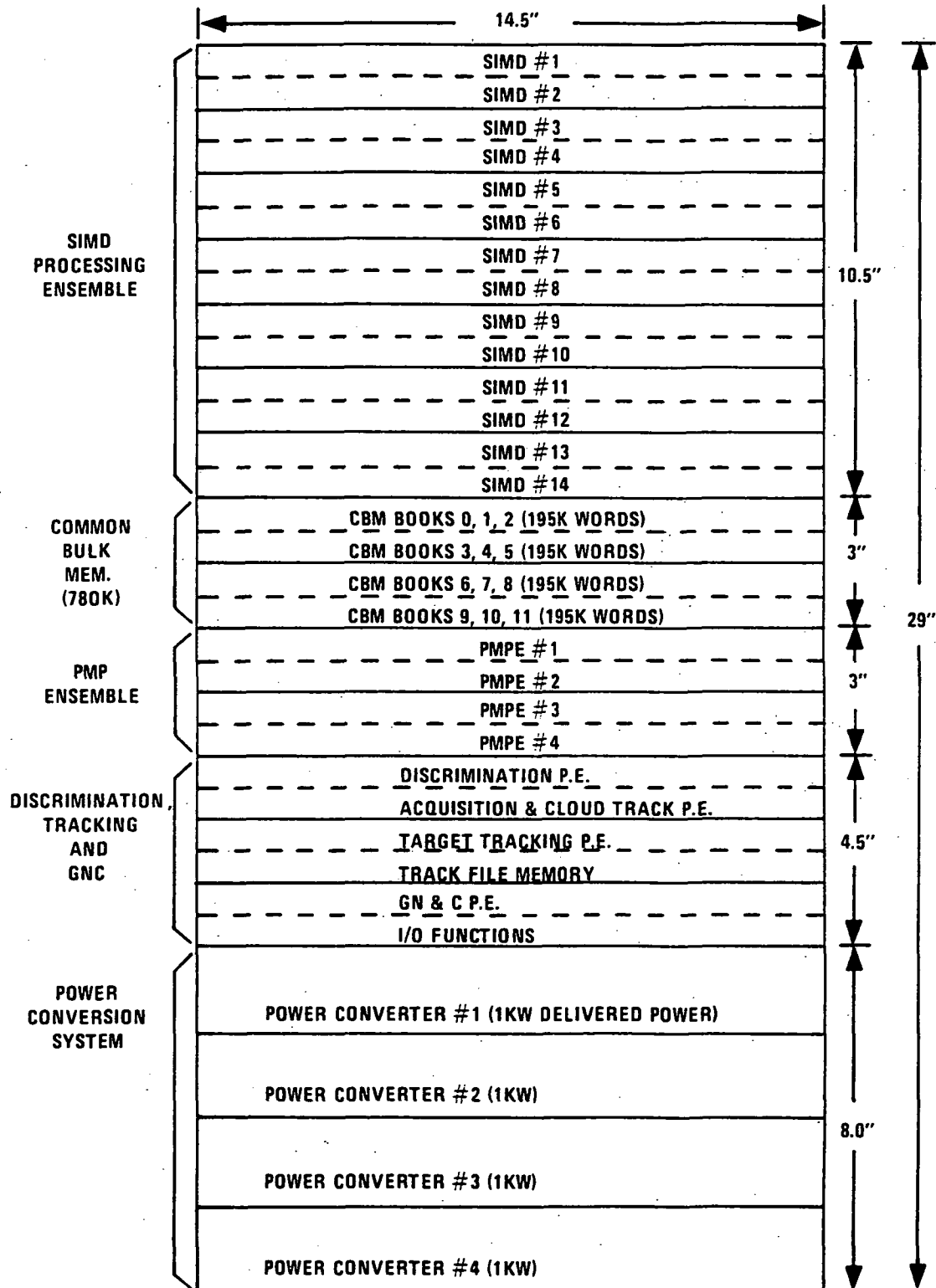
# PACKAGING EXAMPLE (PULSE-MATCH PROCESSOR MODULE)



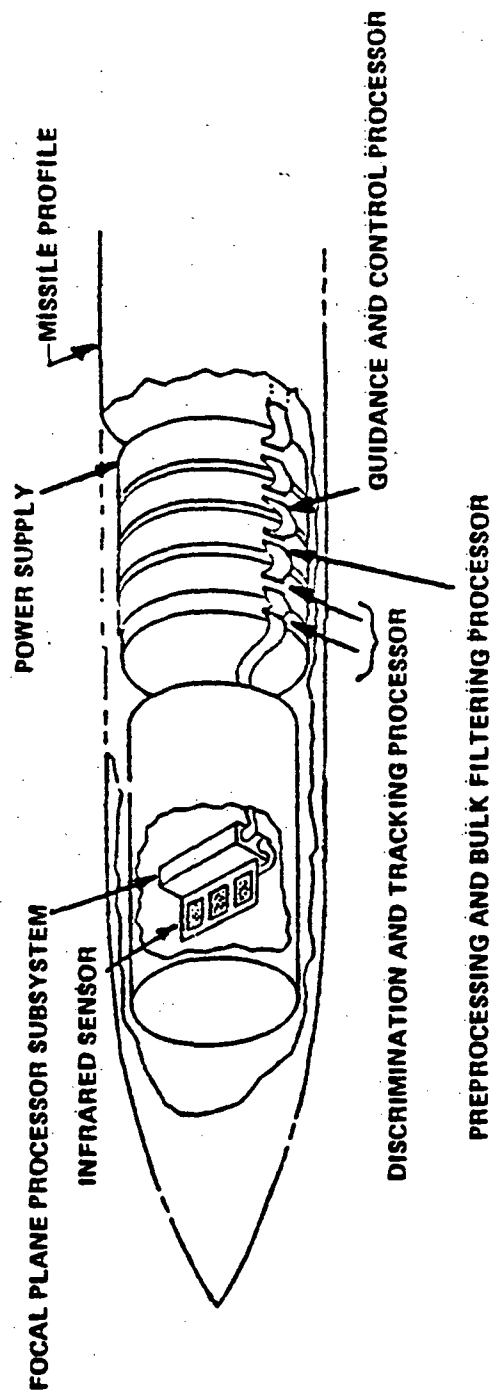
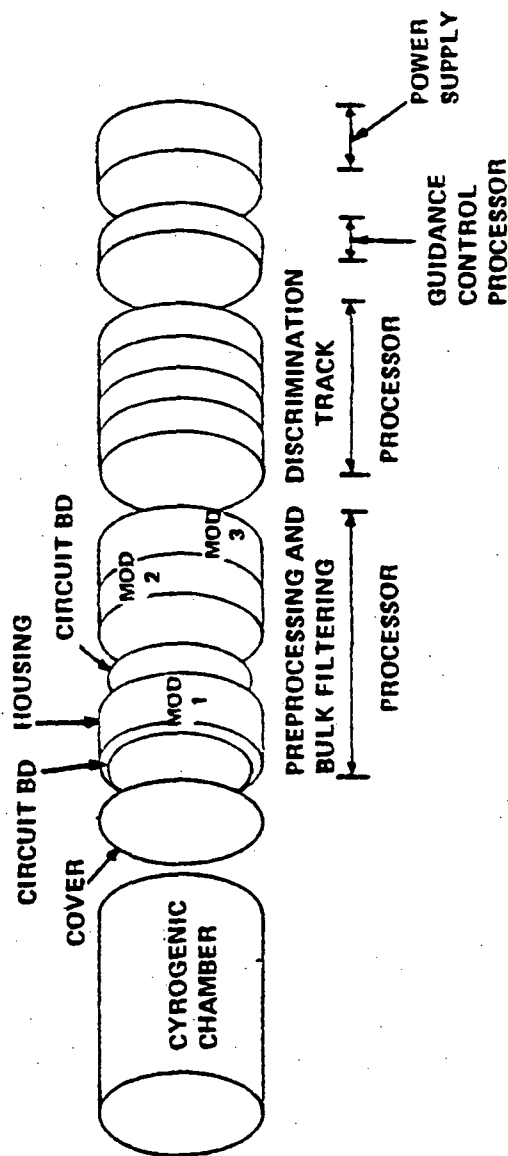
## CHARACTERISTICS

- 200 WATTS
- 14.5" DIAMETER
- TWO 150-PIN I/O CONN.
- OPTIONAL 2" X 2" (SBD) (SENSOR BUS DRIVER)
- 165 in<sup>2</sup>
- 3/4" CENTERS BOARD SPACING

# EXAMPLE OF HYBRID MMBC SYSTEM

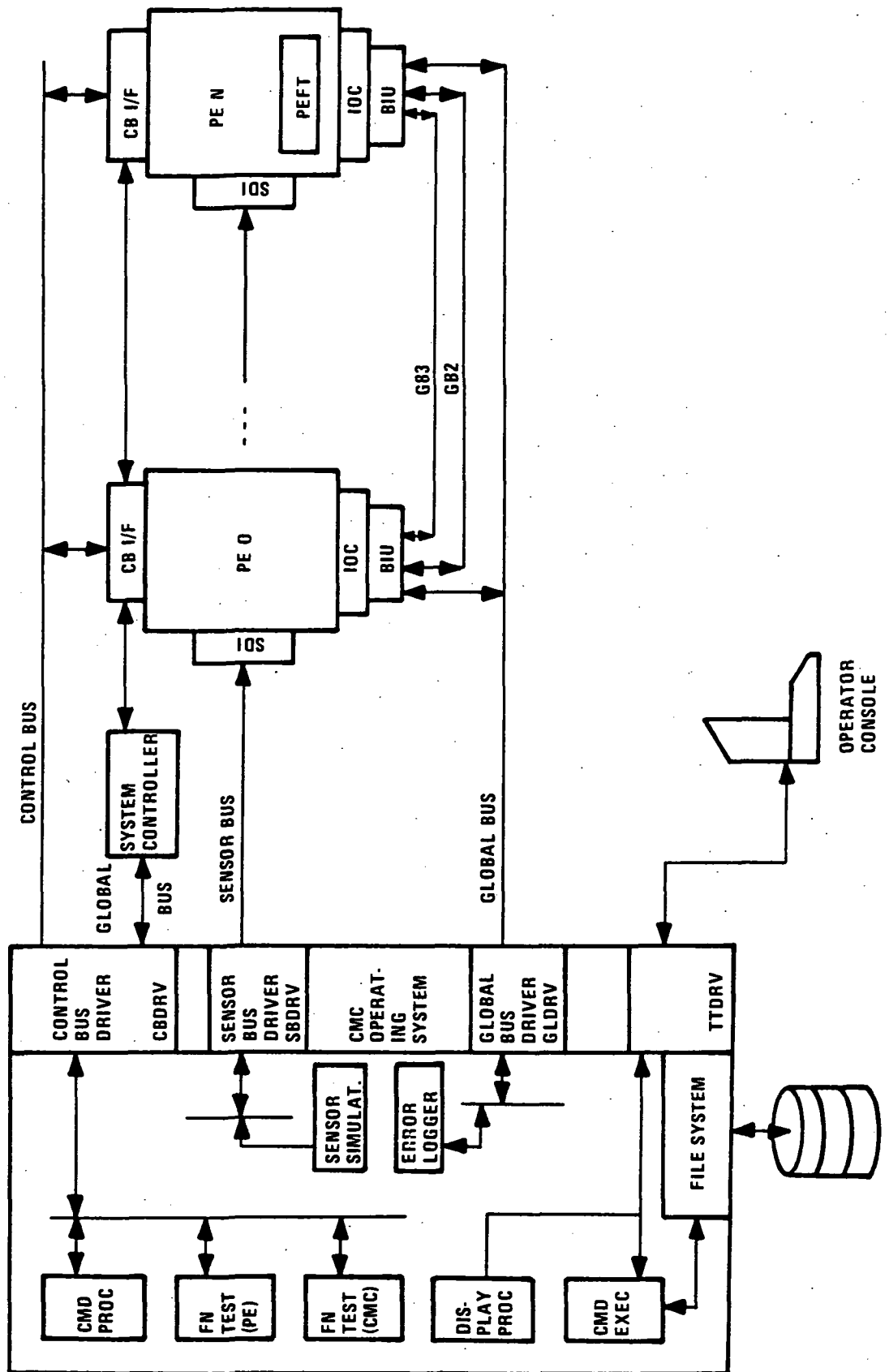


# MODULAR MISSILE BORNE COMPUTERS



- ONBOARD BUDGETS FOR LDS PROBE APPEAR FEASIBLE

# TEST BED

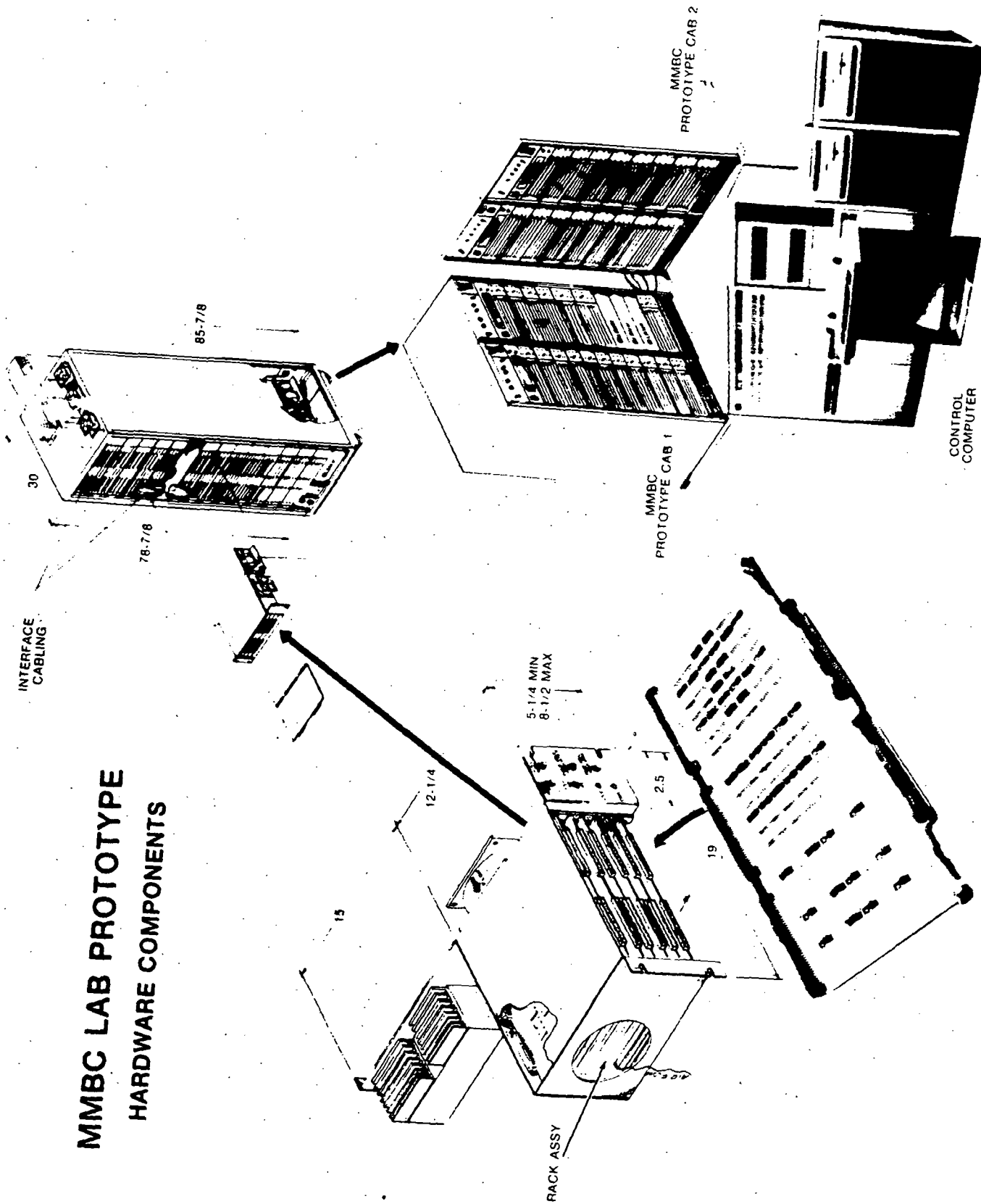




# DIFFERENCES BETWEEN CURRENT SYSTEM & MMBC

CURRENT	MMBC
<ul style="list-style-type: none"> <li>• SINGLE (OR SMALL NO.) OF PE'S</li> <li>• THRUPUT FIXED, ~10-20 MIPS MAX., 1-2 MIPS FLYABLE NOT EXPANDABLE</li> <li>• THRUPUT INVARIANT WITH APPLICATION</li> <li>• SOFTWARE STRUCTURE/COMPLEXITY UNCONTROLLED</li> <li>• GENERALLY SUBJECT TO SINGLE POINT FAILURES</li> <li>• OVERHEAD FUNCTIONS GENERALLY IN SW</li> </ul>	<ul style="list-style-type: none"> <li>• MANY PE'S</li> <li>• EXPANDABLE, THRUPUT VARIABLE FROM ~1 TO 100 + MIPS; MAY BE TUNED TO APPLICATION REQUIREMENTS (FLYABLE)</li> <li>• THRUPUT DEPENDENT ON SW, SW STRUCTURE</li> <li>• STRUCTURED APPROACH EASIEST SW MODULARITY INHERENT, COMPLEXITY CONTROLLED; REQUIRES CAREFUL PARTITIONING</li> <li>• EASILY AVOIDS SINGLE POINT FAILURES; GRACEFULLY DEGRADES WITH FAULTS</li> <li>• HARDWARE IMPLEMENTS MOST OVERHEAD FUNCTIONS (ESPECIALLY THOSE DUE TO MULTI COMPUTER CONFIGURATION</li> </ul>

# MMBC LAB PROTOTYPE HARDWARE COMPONENTS



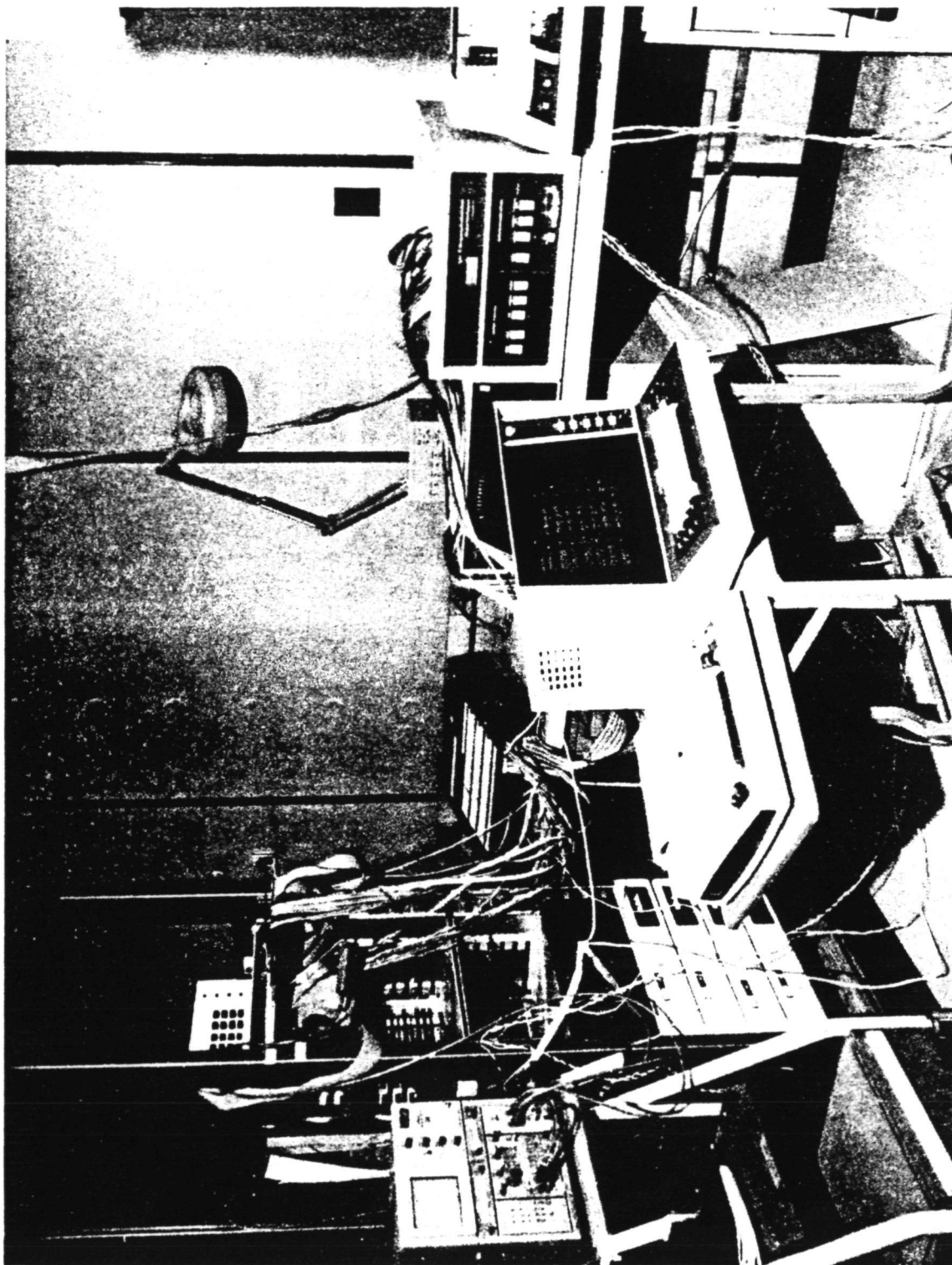


Figure 16. CPU Bus Display Box